



Product Change Notification

Change Notification #: 115064 - 00
Change Title: Intel® RealSense™ Camera SR300,
PCN 115064-00, Transport Media,
Packing Foam Change
Date of Publication: November 15, 2016

Key Characteristics of the Change:

Transport Media

Forecasted Key Milestones:

| | |
|---|--------------|
| Date Customer Must be Ready to Receive Post-Conversion Material: | Dec 05, 2016 |
|---|--------------|

Description of Change to the Customer:

The Intel® RealSense™ Camera SR300 will have the following change:

- The existing foam rings in the current packaging can shift in transport. The existing foam pieces will be adhered together so that movement will no longer be possible.

Example picture of new foam.



Customer Impact of Change and Recommended Action:

No impact on customers.

The packaging change does not affect the functionality of the product. Customers should be aware of the changes and take any necessary steps to insure no impact for their receiving and processing of the product in their manufacturing.

Milestone dates are estimates and subject to change based on business and operational conditions.

Please contact your local Intel Field Sales Rep if you have any further questions about these changes.

Products Affected / Intel Ordering Codes:

| Product Code | MM# |
|----------------|--------|
| 82535IVCHVM | 943228 |
| 82535IVCHVMAMZ | 950128 |

PCN Revision History:

Date of Revision:

November 15, 2016

Revision Number:

00

Reason:

Originally Published PCN



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115064 - 00

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Should you have any issues with the timeline or content of this change, please contact the Intel Representative(s) for your geographic location listed below. No response from customers will be deemed as acceptance of the change and the change will be implemented pursuant to the key milestones set forth in this attached PCN.

Americas Contact: asmo.pcn@intel.com

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